Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.					This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1	IPC Web Site for Information on IPC 1752 Standard Form Type				Form Type ³ Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				rials and Mf	rials and Mfg Information				
Supplie	r Information														
Company name* Company uniq				eque ID			Unique ID Authority				Respons	Response Date*			
nsemi											2025-09-	2025-09-12			
Contact N	lame	Title - Conta	Title - Contact			Phone - Contact*				Email - 0	Email - Contact*				
Product-l	Env-Stewards		Product Envi	uct Enviro Compliance			NA				Product	Product-Env-Stewards@onsemi.com			
uthorize	ed Representative*	Title - Representative				Phone - Representative*				Email - l	Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Date Version Manufacturing Site		acturing Site	V	Veight*	UOM	Unit Type		
		2SK3745	2SK3745LS-1E NCH 10V DRIV		SERIES		2025-09-12	12 KR8		1	764.18	mg	Each		
/Ianufa	cturing Proccess Informa	ition													
	Terminal Plating / Grid Array Material T		Cerminal Base Alloy J-STD-020		STD-020 MSL	Rating	Peak Process Body Temperatur		perature Ma	ire Max Time at Peak Tempera		are Numb	er of Reflow Cyo	cles	
	Matte Tin (Sn) - annealed		CU Alloy NA		A		0	C	30		secono	is 3			
omments	3														
	_						_				•				
or more	information regarding material	composition	nlesse refer to	naga 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges that Gumpany will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Itability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	astislav Drska	-En								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	11.18	mg	Supplier	Silicon (Si)	7440-21-3		11.18	mg
Die Attach	6.0	mg	Supplier	Silver (Ag)	7440-22-4		0.09	mg
			A	Lead (Pb)	7439-92-1	7a	5.61	mg
			Supplier	Tin (Sn)	7440-31-5		0.3	mg
Lead Frame	637.0	mg	Supplier	Iron (Fe)	7439-89-6		0.637	mg
			Supplier	Copper (Cu)	7440-50-8		636.1719	mg
			Supplier	Phosphorus (P)	7723-14-0		0.191	mg
Mold Compound-Black	1090.0	mg		Brominated epoxy resin	proprietary data		18.53	mg
			Supplier	Phenolic Resin	Proprietary Data		87.2	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		16.35	mg
			Supplier	Carbon Black (C)	1333-86-4		2.725	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		114.45	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		850.7451	mg
Plating	16.0	mg	Supplier	Tin (Sn)	7440-31-5		16	mg
Wire Bond - Al	4.0	mg	Supplier	Aluminum (Al)	7429-90-5		4	mg